

I hereby claim the benefit under 35 U.S.C. Section 119(e) of any United States provisional application(s) listed below:

(Application Serial Number)

(Filing Date)

(Application Serial Number)

(Filing Date)

(Application Serial Number)

(Filing Date)

I hereby claim the benefit under 35 U.S.C. Section 120 of any United States application(s), or Section 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, C.F.R., Section 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

Application Serial No.

Filing Date

**Status – patented,
pending, abandoned**

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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1-00 Full name of sole or first inventor: Shusaku OKAMOTOInventor's signature: Shusaku OkamotoDate: June 12, 2002Residence: Osaka, JapanCitizenship: JapanPost Office Address: 39-65-101, Nasuzukuri-kitamachi, Hirakata-shi, Osaka 573-0083, Japan2-00 Full name of second joint inventor, if any: Masamichi NAKAGAWASecond Inventor's signature: Masamichi NakagawaDate: June 12, 2002Residence: Osaka, JapanCitizenship: JapanPost Office Address: 22-5-304, Fujisaka-kitamachi, Hirakata-shi, Osaka 573-0151, Japan

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